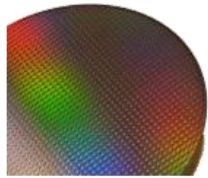


2D and 3D
Imaging markets
overview
and
wafer level optics
opportunities

EPIC Event at
Suss MicroOptics

Neuchâtel, Switzerland
November 7, 2019



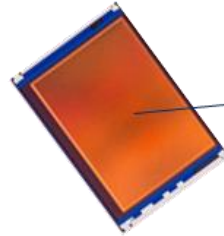
courtesy of Sony

Wafers &
raw material

Optics



Module Assy



Sensor array

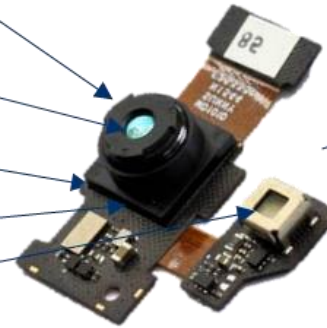
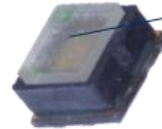
Sub-components
Sensor, optics
& illumination



AF & OIS



Illuminator



courtesy of PMD Tech

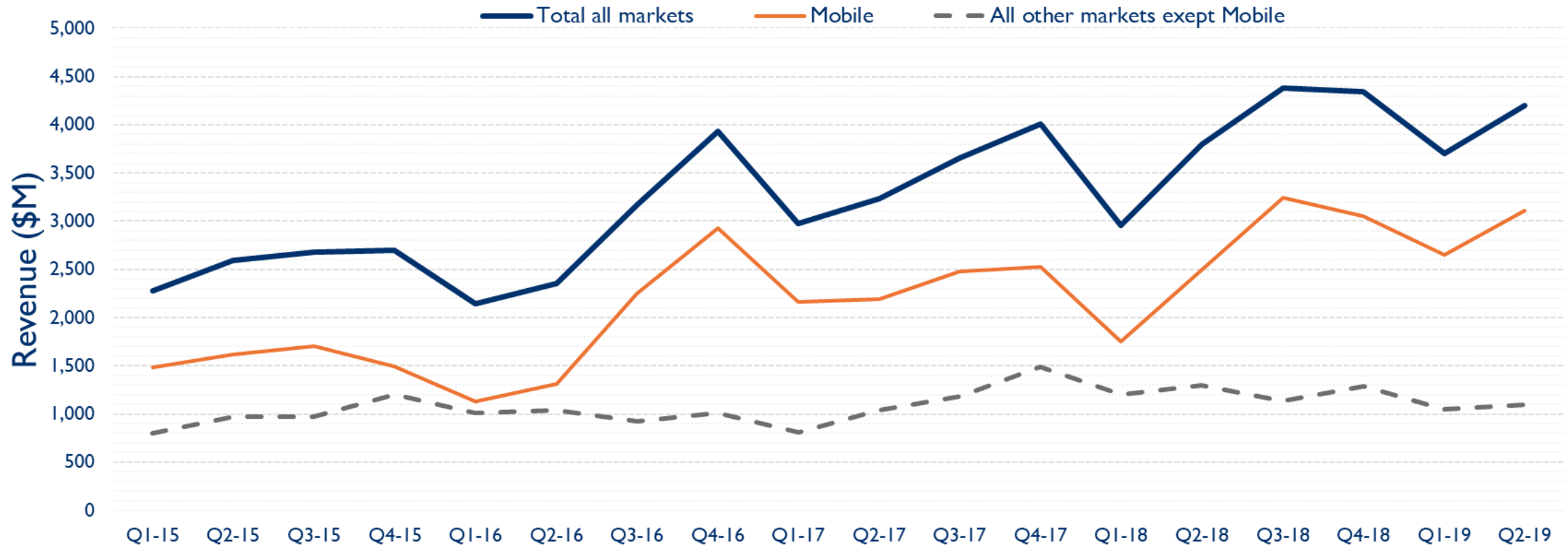
Camera
Modules



courtesy of Apple

Systems

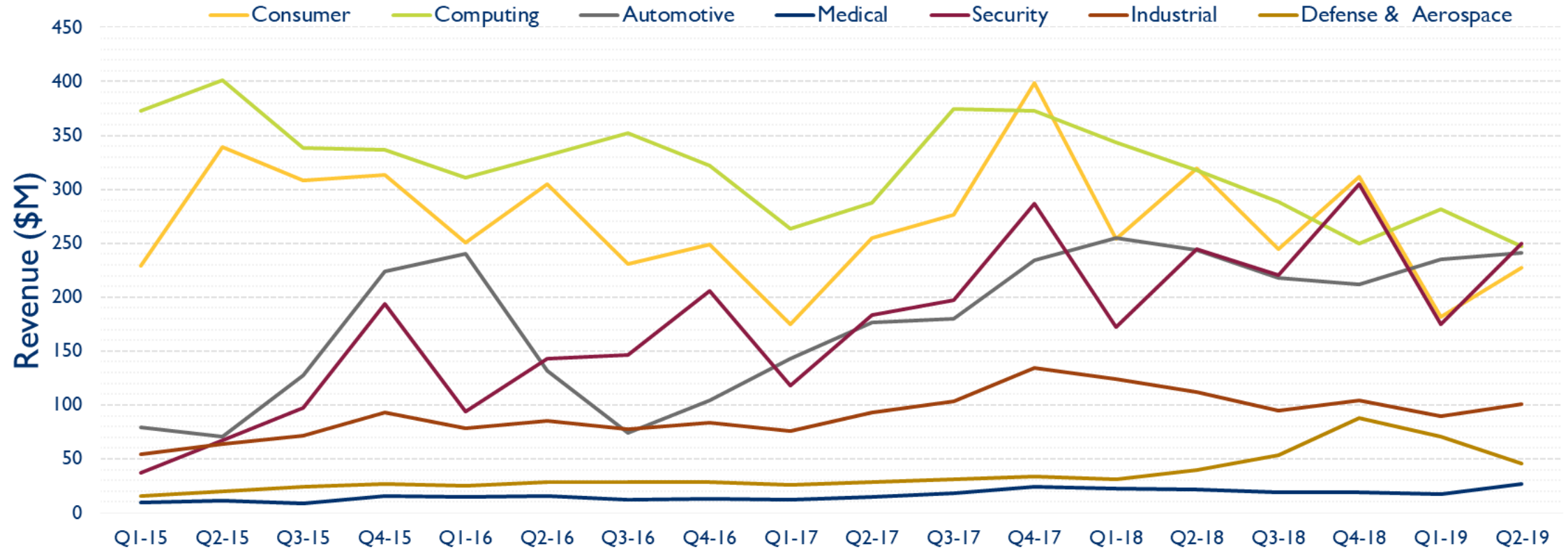
Revenue Quarterly CIS - mobile vs. all other markets (in \$M)



- CIS market is dominated by mobile which represent 68% of revenues
- No effect perceived of the smartphone market saturation...yet
- Proliferation of cameras per phone is the key new factor for growth.



Revenue Quarterly CIS - all other markets (in \$M)

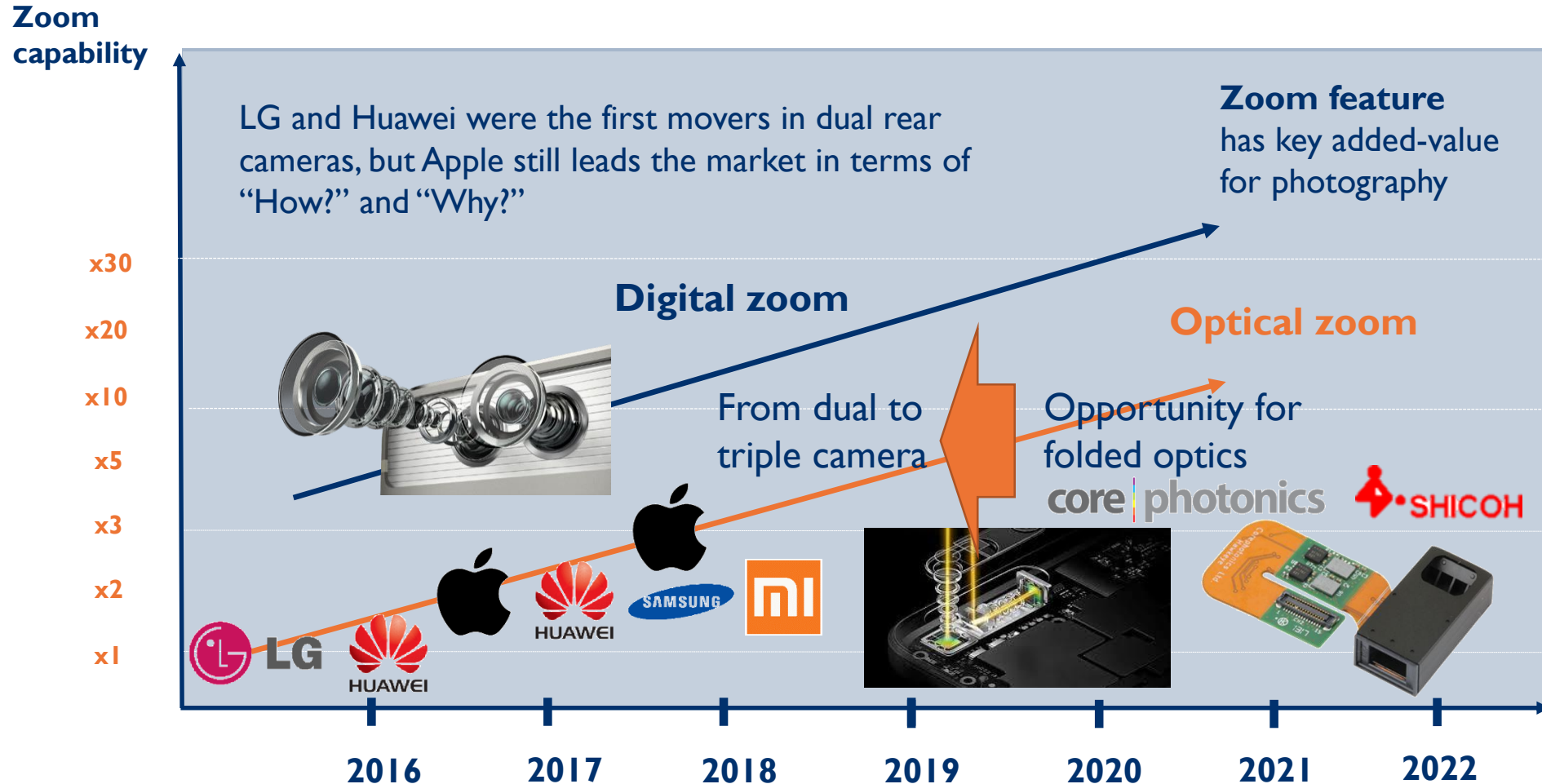


- Automotive and Security markets now on par with Consumer and Computing which are on a multi year sliding slope
- Automotive and Security plateaued in the trailing last 4 quarters but should point north again along CN and US market recovery

MOBILE TECHNOLOGY TREND

Zoom technology

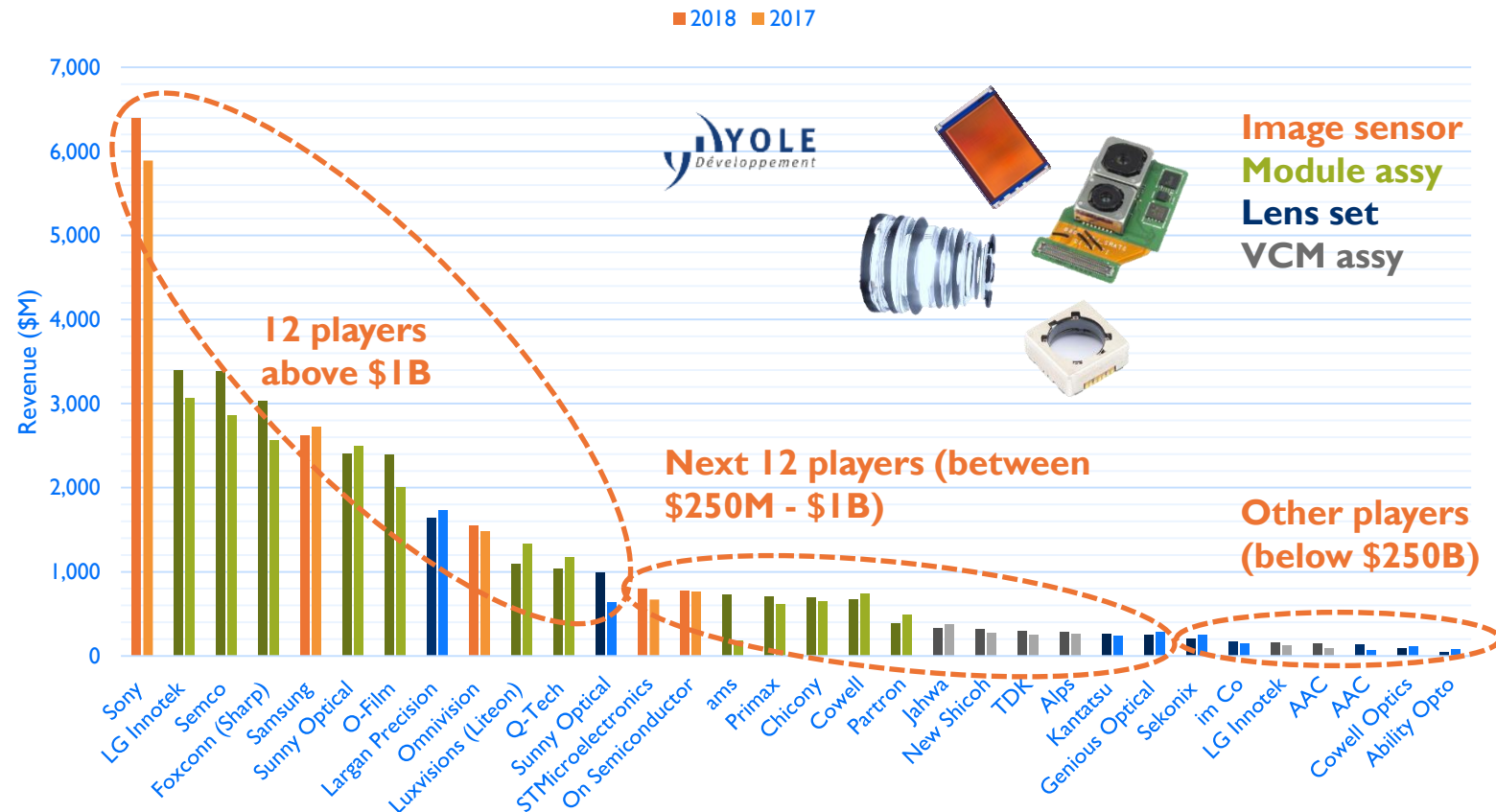
Apple is starting a new race towards optical zoom capability



CAMERA MODULE INDUSTRY - ECOSYSTEM

2018 “state of the industry”

Camera module industry - main players



The CCM ecosystem features 12 companies with revenue exceeding \$1B

OPTICAL ELEMENTS & THEIR FUNCTIONS

Optical Elements

Passive elements

Lens



Lenses are used to shape light beams.

Mirror



Mirrors are used to shape or deflect light beams.

Filter



Filters are used to select wavelength.

Window



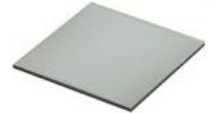
Windows are used to protect optical elements and let the light through.

Diffuser



Diffusers are used to homogenize the light emitted from a punctual source.

Holographic elements



Holographic elements are used to convey light into waveguides for augmented reality.

Diffraction grating



Diffraction gratings are used to create regular light patterns from punctual sources.

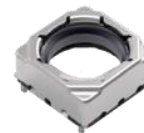
Diffractive elements



Diffractive elements are used to convey light into waveguides for augmented reality.

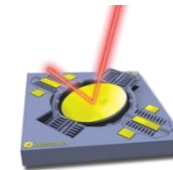
Active elements

AF & OIS



Autofocus and Optical Image Stabilization is used in photography.

Beam scanner



Beam scanners are used to scan light with time.

Spatial Light Modulator

Spatial light modulators modulate light with respect to space and time.

Optical elements can be classified as passive or active: Changing with time or not.

Free-form lenses

Free-form lens is the logical next step to address some current issues:

- Illumination optics
- Zoom optics
- Periscope optics
- 180° panoramic optics

DynaOptics

IMMERVISION

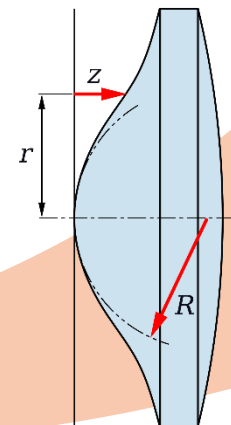
Anteryon

Freeform lens

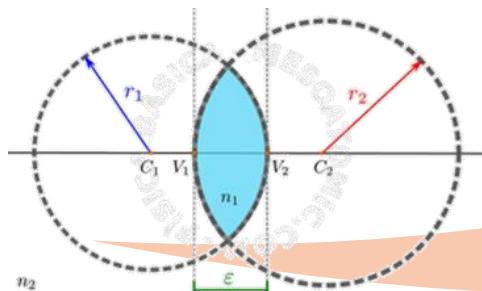


courtesy of Anteryon

Aspherical lens



Spherical lens

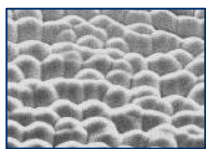


Lens manufacturing methods are evolving too, offering the optical designer more degrees of freedom

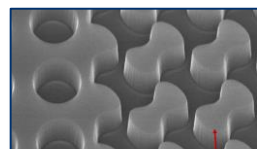
OPTICAL MICROTECHNOLOGIES - TECHNOLOGY ROADMAP



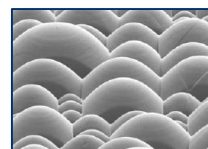
Smartphone



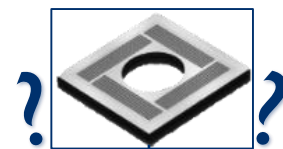
Diffuser for 3D sensing (ToF)



Diffractive gratings for 3D sensing (SL)



Random MLA for 3D sensing (ToF)



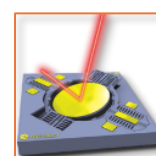
MEMS or Liquid Crystals challenge in autofocus?



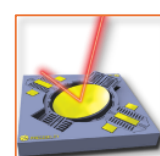
Automotive



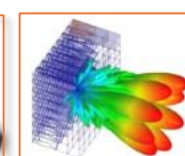
DMD for Headlamps



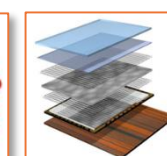
MEMS Scanner for LiDAR



MEMS Scanner for Headlamps

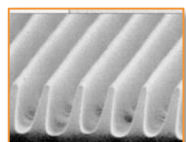


OPA for LiDAR

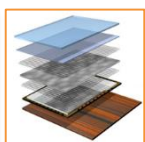


LCOS for LiDAR

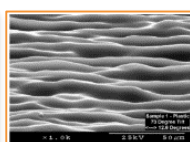
AR HMD



Diffractive Optical Elements



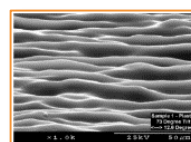
LCOS



HOE on glass



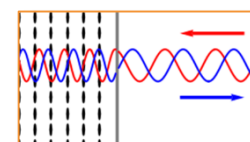
DMD



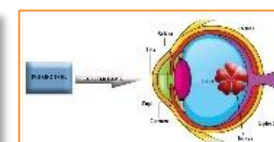
HOE on plastic



Micro LED display



Phase modulated LCOS (Holography)



Retinal projection display



WLO MARKET SEGMENTATION

Known WLO application
Potential WLO application
Key application

| Market | Application | Fresnel Lens | Lens | Diffuser | DOE | MLA | AF | OIS |
|------------|------------------|----------------|---|----------------------|--------------------|--------------------|---------------------|-----------------|
| Industrial | Barcode reader | | | | | | Camera AF | |
| | Power laser | | | | Illuminator | Light combiner | | |
| Medical | Dermatology | | | | | Dot illuminator | | |
| | Endoscopy | | Camera lens | | | | | |
| Automotive | DMS & lidar | | | Illuminator | | Light combiner | | |
| Consumer | Smart watch | Pulse Oxymeter | Camera lens | | | | Camera AF | |
| | Other 3D & AR/VR | | 3D dot illuminator Multi-pt. ranger? | 3D flood illuminator | 3D dot illuminator | 3D dot illuminator | Retina projector AF | |
| Mobile | Smartphones | Flash lens | 3D dot illuminator | 3D flood illuminator | 3D dot illuminator | 3D dot illuminator | Front camera AF | Rear camera OIS |

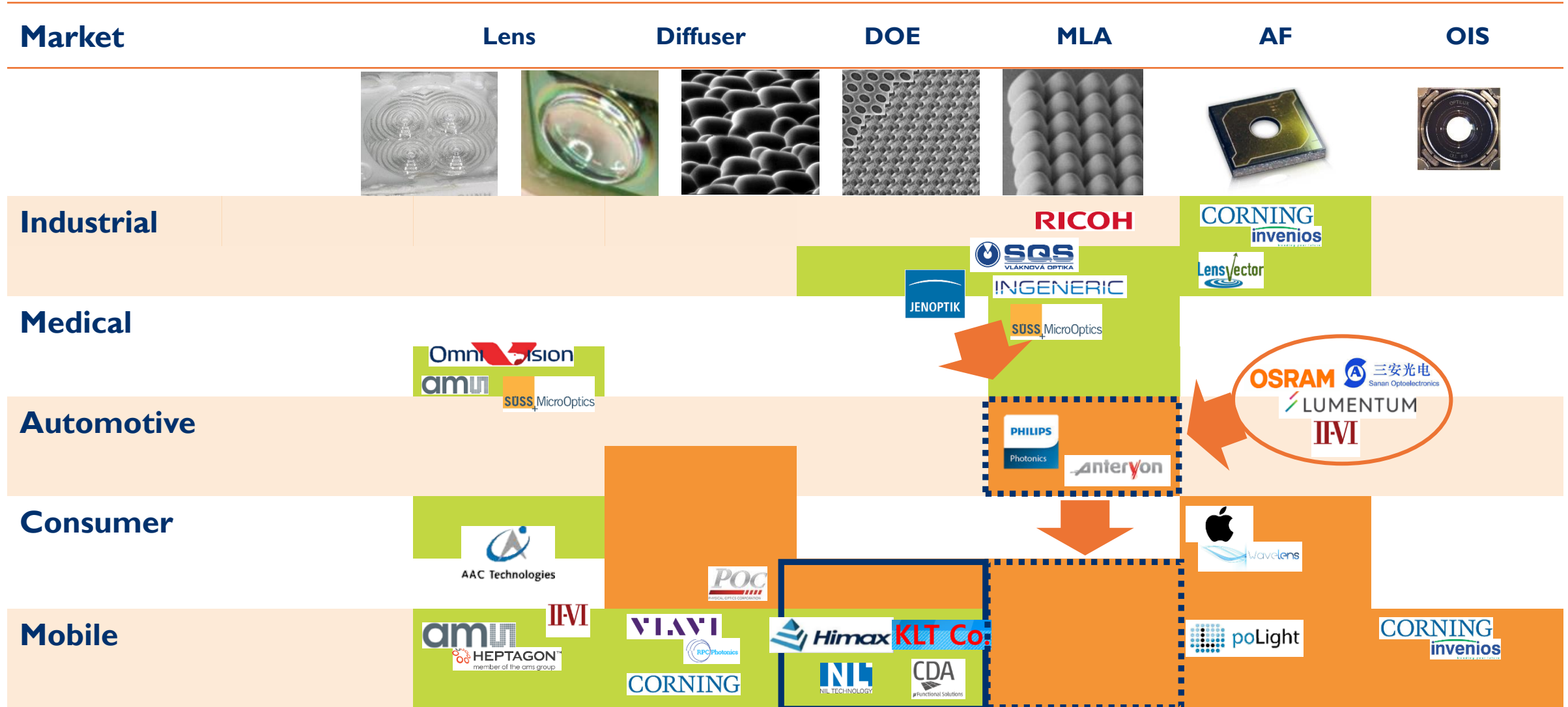
WLO ECOSYSTEM MAPPING



Known WLO application

Potential WLO application

Key application



WAFER-LEVEL CAMERA MODULE PLAYERS



- WLO is a key technology for 3D sensing
- Multiple acquisitions are a direct consequence

➤ Recent acquisitions

WAFER-LEVEL OPTICS - SUPPLY CHAINS



| Market | Glass supplier | Tx emitter | Rx sensor | WLO player | System OEM |
|------------|------------------|----------------------|------------|-----------------------------|--------------------------------|
| Medical | AGC | tecnisco | OmniVision | SQS VLAKNOVA OPTIKA | SUSS MicroTec |
| | | | | SUSS MicroOptics | MediQus Ambu |
| Industrial | SCHOTT | PHILIPS Photonics | OmniVision | INGENERIC | ASML TRUMPF |
| | | | | JENOPTIK | eos |
| Automotive | planoptik | amun | OmniVision | anteryon | OUSTER INNOVIZ TECHNOLOGIES |
| | | | | amun | |
| Computing | CORNING | IQE | LUMENTUM | ST life.augmented | Apple |
| | | | | Himax | |
| Mobile | AAC Technologies | amun | OmniVision | CDA Functional Solutions | HUAWEI |
| | | | | LUMENTUM | MI oppo |

WAFER-LEVEL OPTICS - REVENUE FORECAST

by applications (in \$M)

The 3D-sensing illuminator serving mobile and consumer is dominant

2012 - 2024 WLO - revenue forecast (in \$M)



OPTICAL ELEMENT FORECAST BY APPLICATION

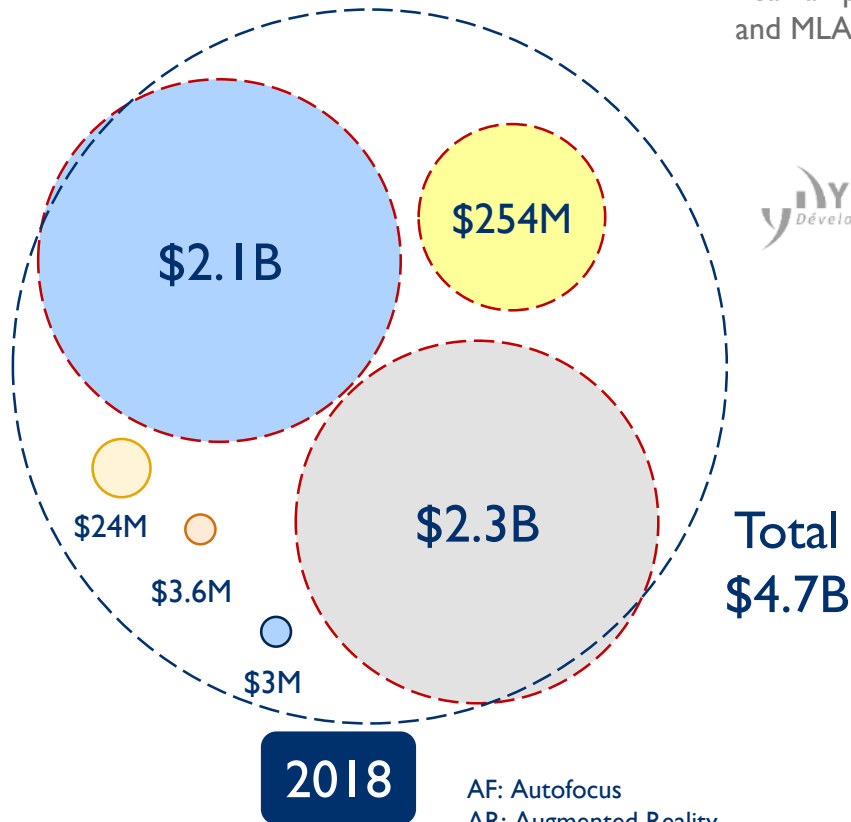
2018-2024 Forecast

- Mobile phones lens elements
- Mobile phones AF & OIS
- DMD and LCOS for AR HMD
- DOE and HOE for AR HMD

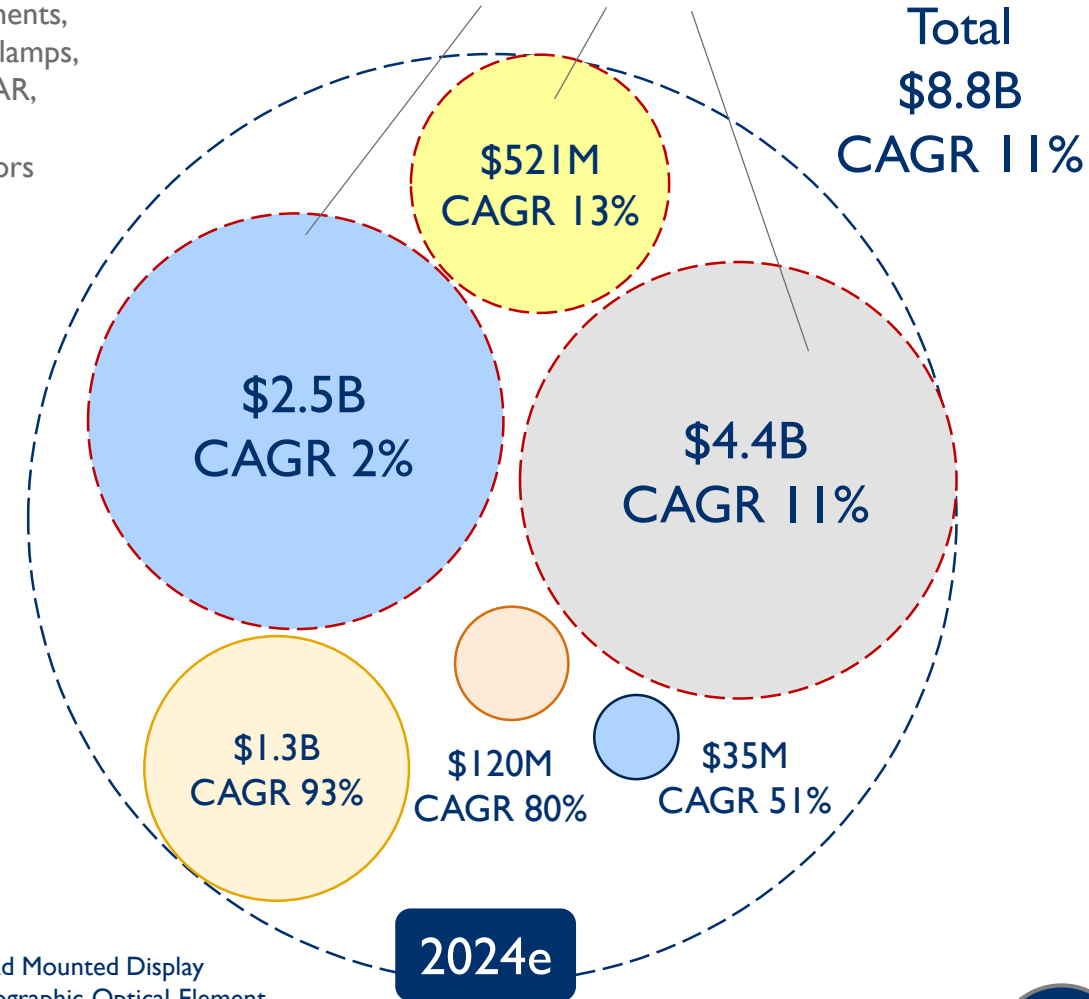
- Diffusers and diffractive elements for 3D sensing in smartphones
- Automotive optical elements, including DMD for headlamps, MEMS scanners for LiDAR, LiDAR lens elements, headlamp lenses, reflectors and MLAs.

These three segments are only partially impacted by micro technologies.

Total
\$8.8B
CAGR 11%



AF: Autofocus
AR: Augmented Reality
DMD: Digital Micromirror Device
DOE: Diffractive Optical Element

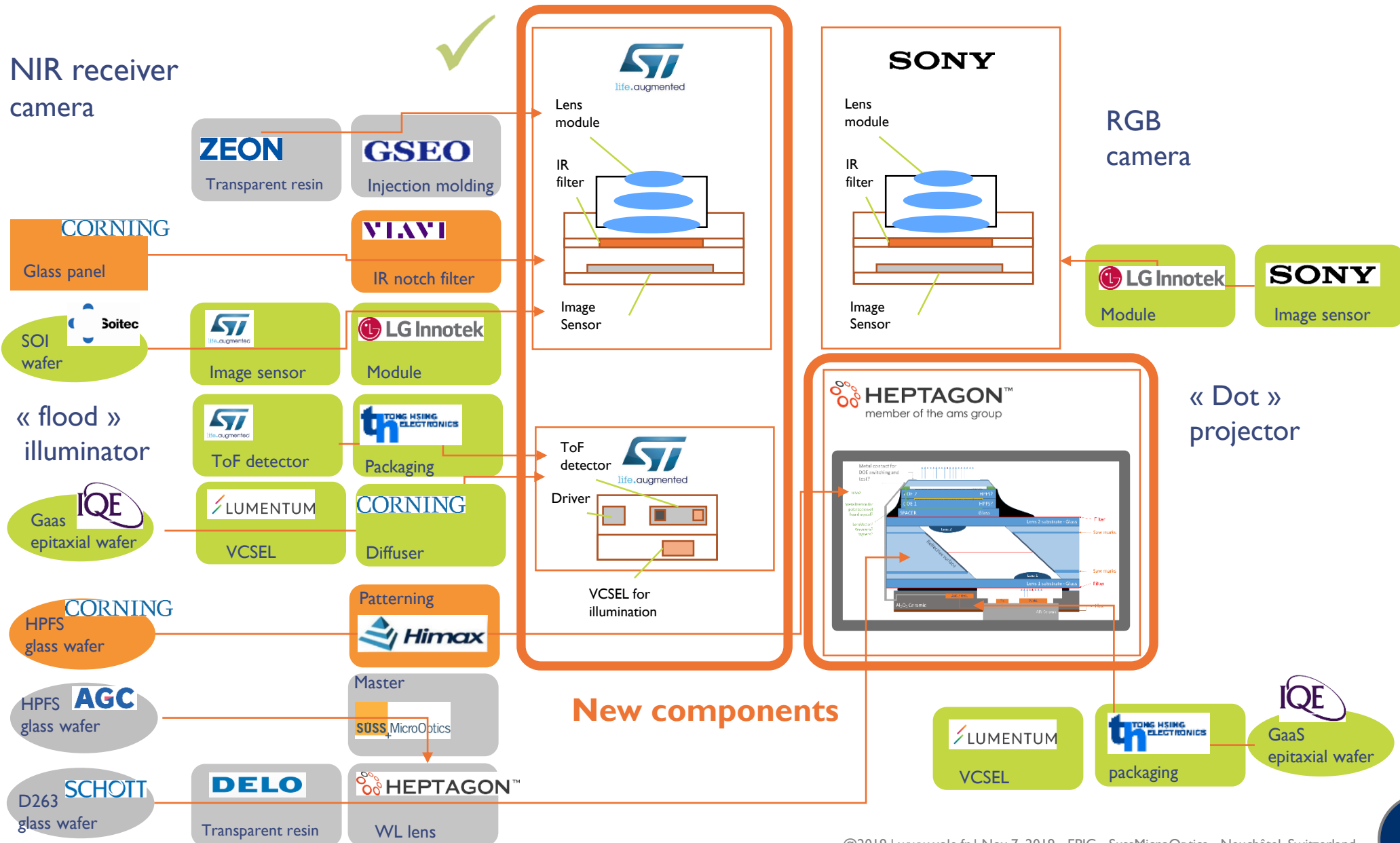


HMD: Head Mounted Display
HOE: Holographic Optical Element
MLA: Micro Lens Array
OIS: Optical Image Stabilization

3D-SENSING SUPPLY CHAIN COMPLEXITY - IPHONE X



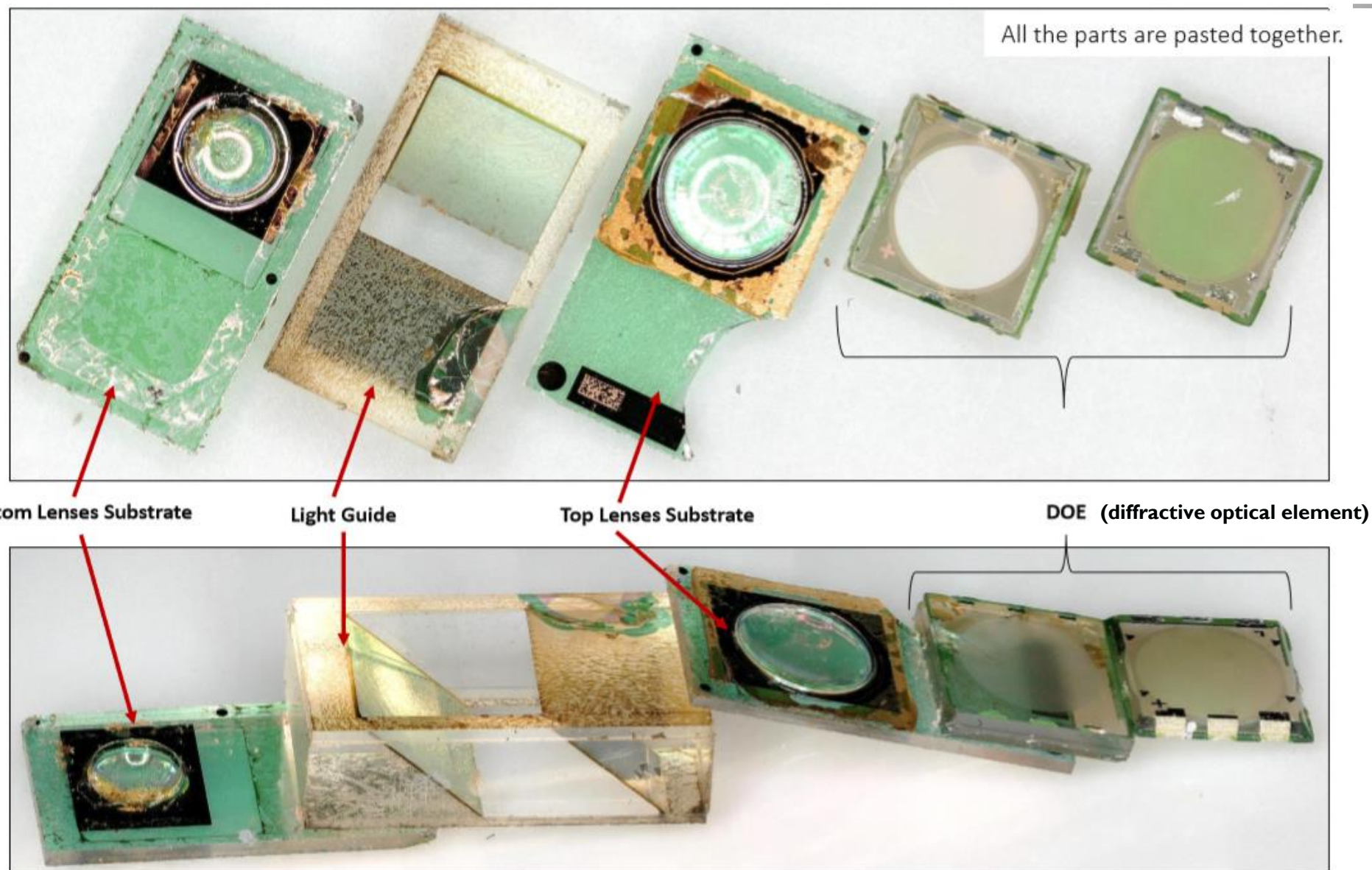
The TrueDepth camera adds new devices alongside the front-facing camera



DOT ILLUMINATOR - IPHONE X

Folded optical path - WLO (2/2)

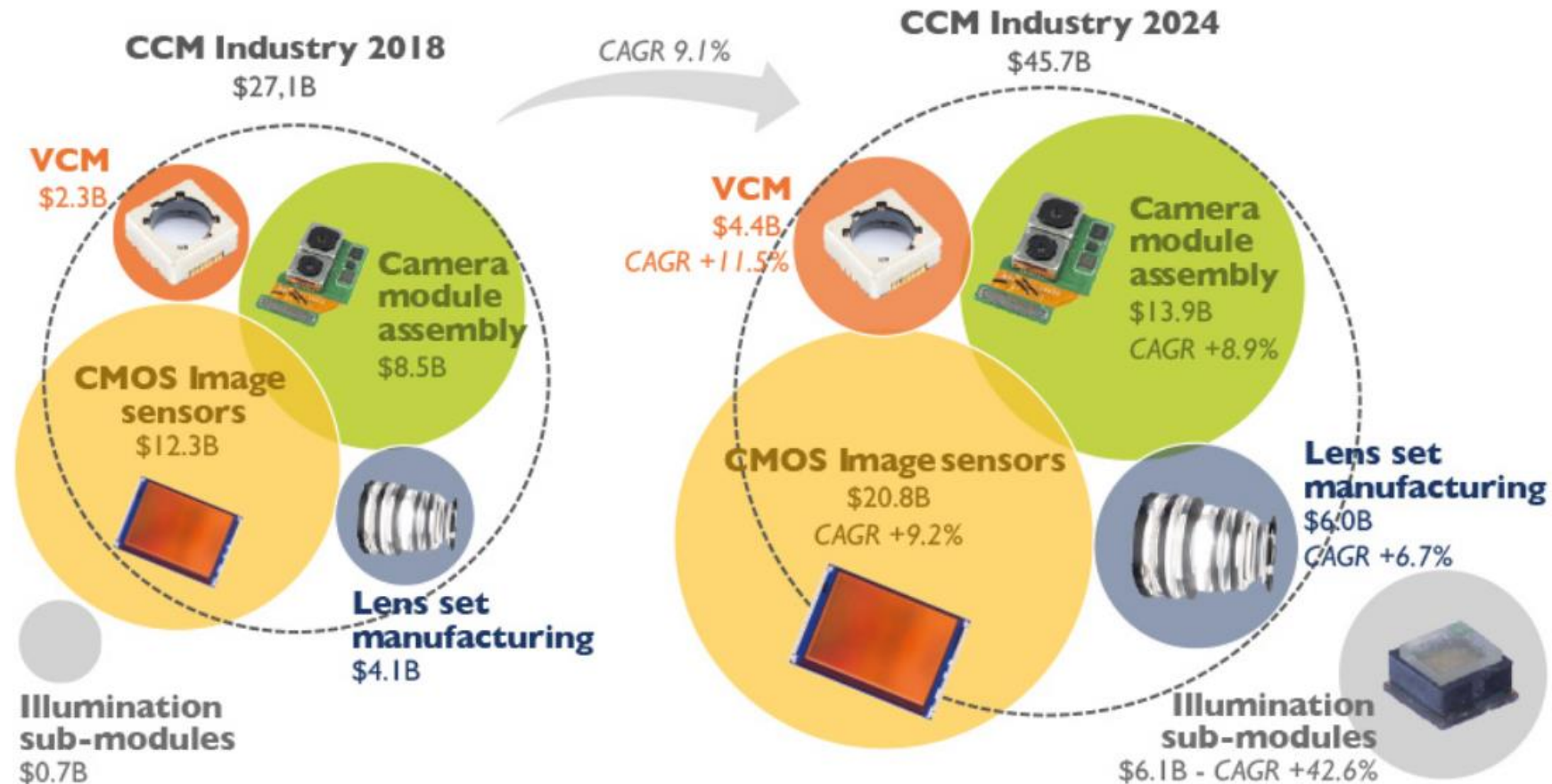
Folded path is
panel-based
DOE is wafer-
based



CCM REVENUE FORECAST (\$B)

2012 – 2024 CCM revenue forecast (\$B)

(Source: Status of the Camera Module Industry 2019 - Focus on Wafer Level Optics, Yole Développement, February 2019)





Yole Développement

From Technologies to Market



Photonics & Sensing

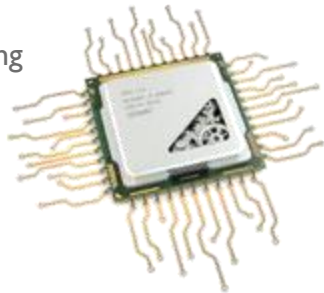
- › Photonics
- › Lighting
- › Imaging
- › Sensing & Actuating
- › Display



- Photonics, BioPhotonics & Optoelectronics
- 2D/3D/NIR/FIR Imaging
- Solid-State Lighting
- MEMS, Microfluidics, Sensors & Actuators
- BioMEMS & Medical Microsystems
- Inkjet and accurate dispensing
- Display

Semiconductor Manufacturing & Computing

- › Advanced Packaging, Assembly & Substrates
- › Semiconductor Manufacturing
- › Memory
- › Computing



Power & Wireless

- › RF Devices & Technologies
- › Compound Semiconductors & Emerging Materials
- › Power Electronics
- › Batteries & Energy Management



4 PRODUCTS AND SERVICES



125+
reports
per year

160+
teardown
per year



○ Syndicated reports

- Market data & research, marketing analysis
- Technology analysis
- Market & technology reports
- Patent investigation and patent infringement risk analysis
- Teardowns & reverse costing analysis
- Cost simulation tool

www.i-Micronews.com/reports

1

○ Consulting and Analysis

- Technology analysis
- Strategy consulting
- Reverse engineering & costing
- Patent analysis
- Design and characterization of innovative optical systems
- Financial services (due diligence, M&A with our partner)

www.yole.fr

2

6 monitors per quarter

○ Monitors

- Monthly and/or Quarterly update
- Excel database covering supply, demand, and technology
- Price, market, demand and production forecasts
- Supplier market shares

www.i-Micronews.com/reports

3

○ Media

- i-Micronews.com website
- @Micronews e-newsletter
- Communication & webcast services
- Events: TechDays, forums,...

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4

Yole Group of Companies



Market, technology and strategy
consulting

www.yole.fr



Manufacturing costs analysis
Teardown and reverse engineering
Cost simulation tools

www.systemplus.fr



IP analysis
Patent assessment

www.knowmade.fr



Design and characterization of
innovative optical systems

www.piseo.fr



Innovation and business maker

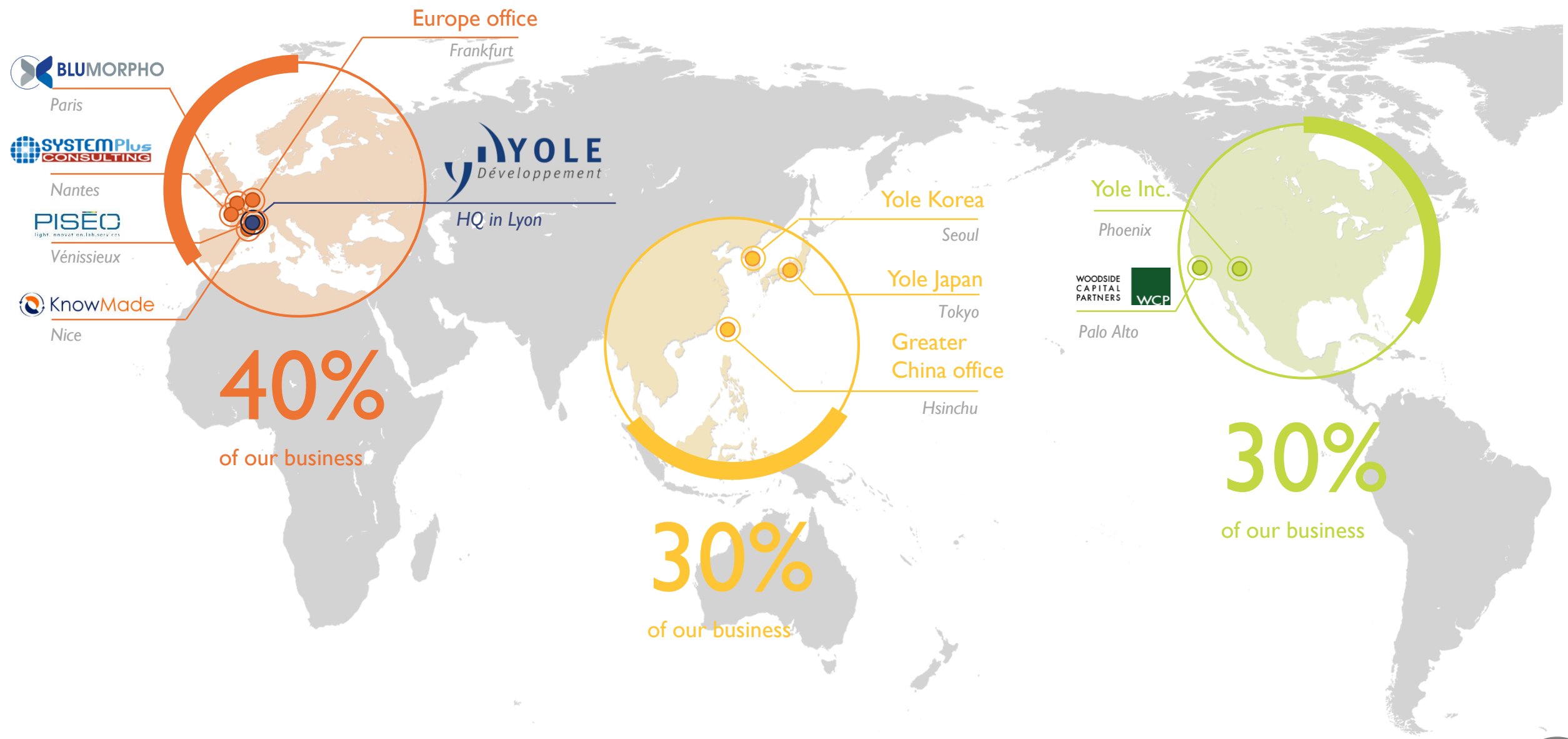
www.bmorpho.com

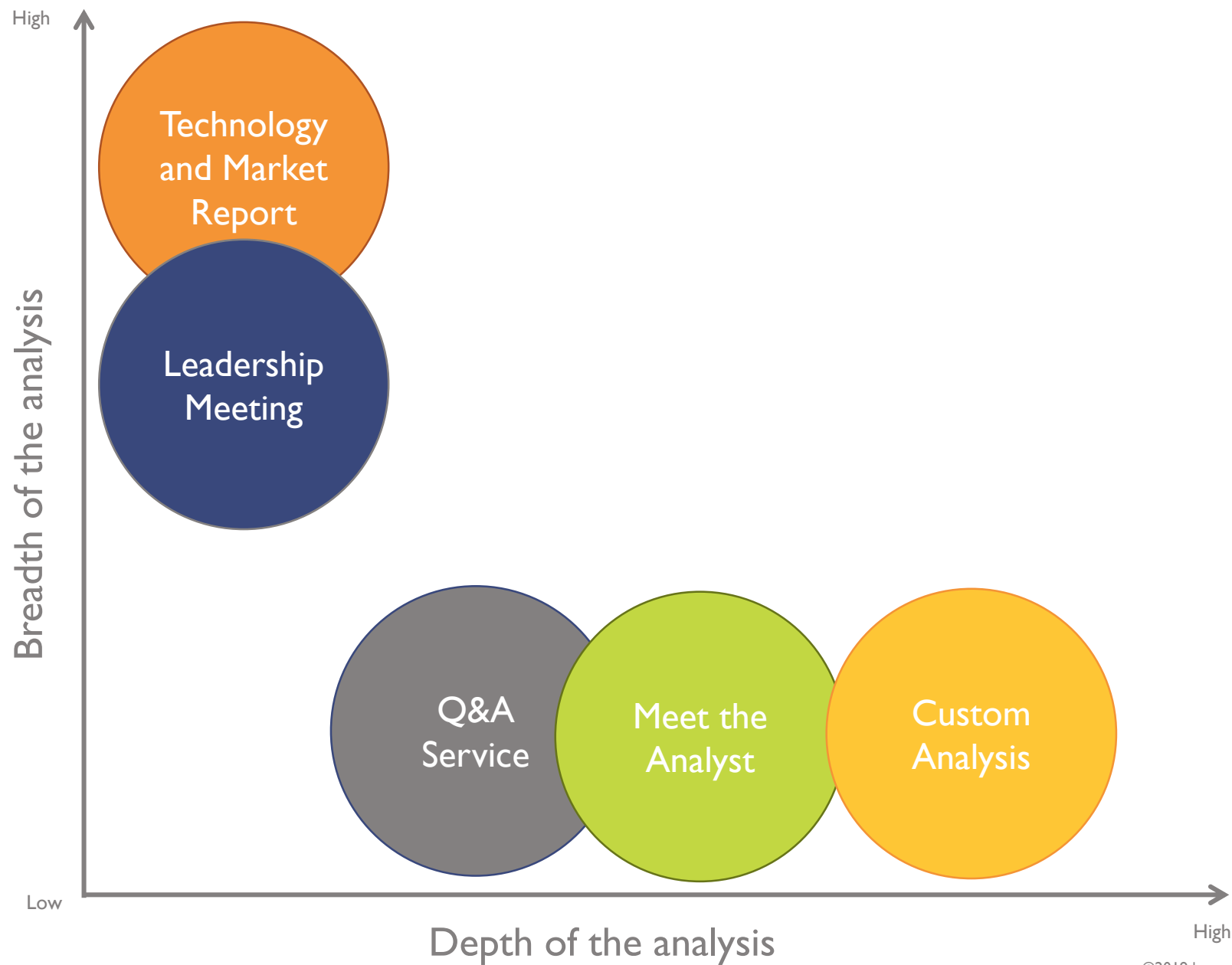


Due diligence

www.yole.fr

OUR GLOBAL ACTIVITY





SERVING THE ENTIRE SUPPLY CHAIN



Integrators, end-users and software developers

DENSO
Crafting the Core



SONY

Canon

Panasonic



TOSHIBA
Leading Innovation >>>

Device manufacturers



BOSCH



ANALOG DEVICES



TEXAS INSTRUMENTS

InvenSense



amun

OSRAM

Suppliers: material, equipment, OSAT, foundries...



Fraunhofer



Daiwa
Securities Group Inc.



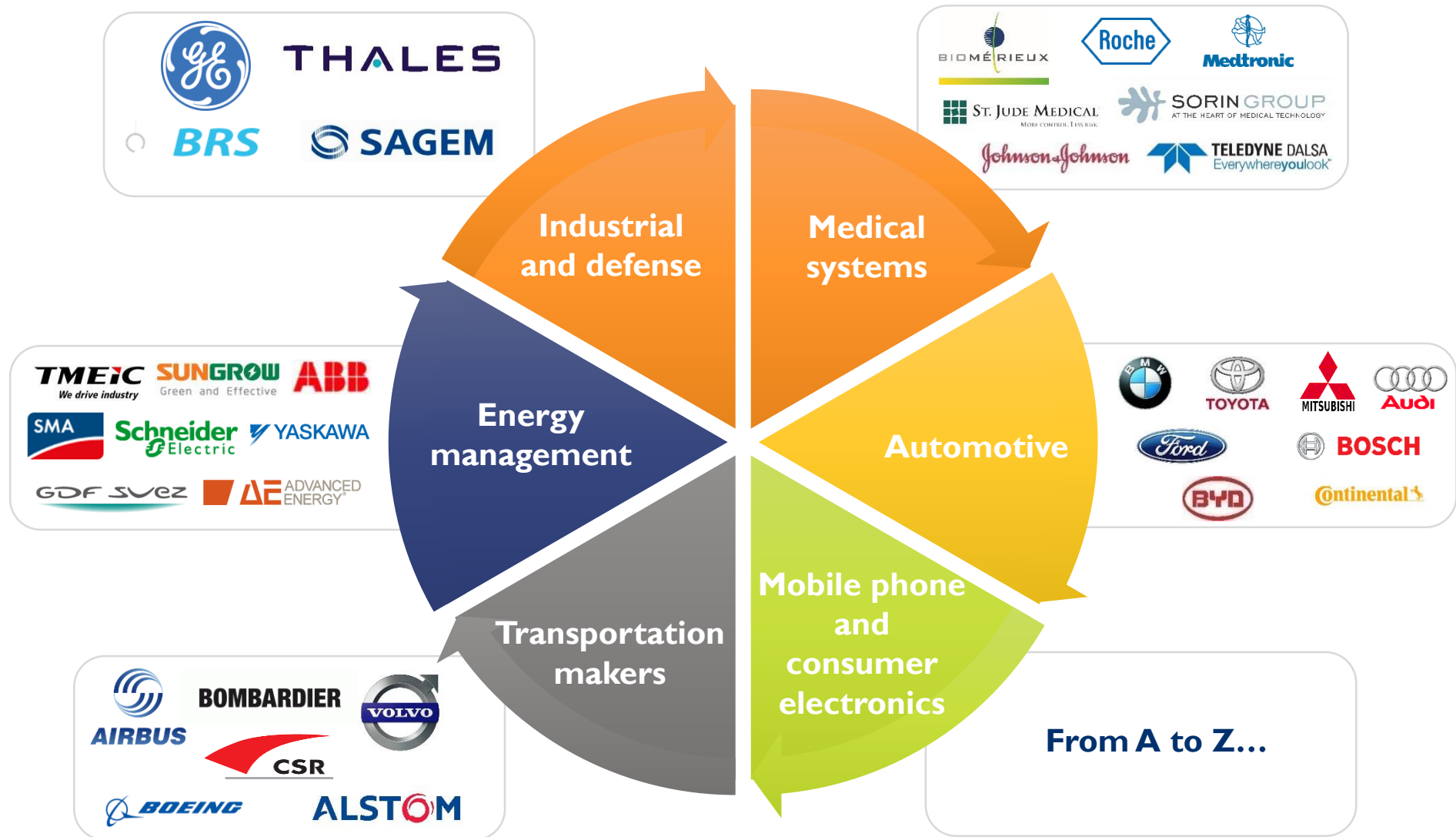
Financial investors, R&D centers

Our analysts provide market analysis, technology evaluation, and business plans along the entire supply chain

SERVING MULTIPLE INDUSTRIAL FIELDS



We work across multiples industries to understand the impact of More-than-Moore technologies from device to system





- Over the course of more than 20 years, Yole Développement has grown to become a group of companies. Together with System Plus Consulting and KnowMade, we now provide marketing, technology and strategy consulting, media and corporate finance services, reverse costing, structure, process and cost analysis services and well as intellectual property (IP) and patent analysis. Together, our group of companies is collaborating ever closer and therefore will offer, in 2019, a collection of over 125 reports and 10 new monitors. Combining respective expertise and methodologies from the three companies, they cover:

- MEMS & Sensors
- RF devices & technologies
- Medical technologies
- Semiconductor Manufacturing
- Advanced packaging
- Memory
- Batteries and energy management
- Power electronics
- Compound semiconductors
- Solid state lighting
- Displays
- Software
- Imaging
- Photonics

- If you are looking for:
 - An analysis of your product market and technology
 - A review of how your competitors are evolving
 - An understanding of your manufacturing and production costs
 - An understanding of your industry's technology roadmap and related IPs
 - A clear view supply chain evolution

Our reports and monitors are for you!

- Our team of over 70 analysts, including PhD and MBA qualified industry veterans from Yole Développement, System Plus Consulting and KnowMade, collect information, identify trends, challenges, emerging markets, and competitive environments. They turn that information into results and give you a complete picture of your industry's landscape. In the past 20 years, we have worked on more than 2,000 projects, interacting with technology professionals and high-level opinion makers from the main players of their industries and realized more than 5,000 interviews per year.

WHAT TO EXPECT IN 2019?

In 2019 we will extend our offering with a new 'monitor' product which provides more updates on your industry during the year. The Yole Group of Companies is also building on and expanding its investigations of the memory industry. Moreover, in parallel, the Yole Group reaffirms its commitment to a new collection of reports mixing software and hardware and is increasing its involvement in displays, radio-frequency (RF) technology, advanced substrates, batteries and compound semiconductors. Discover our 2019 program right now, and ensure you get a true vision of the industry. Stay tuned!



www.i-Micronews.com



18 fields of excellence combined with six markets to provide a complete picture of your industry landscape

Market – Technology – Strategy – by Yole Développement

Yole Développement (Yole) offers market reports including quantitative market forecasts, technology trends, company strategy evaluation and indepth application analyses. Yole will publish more than 55 reports in 2019, with our partner PISEO contributing to some of the lighting reports.

Reverse Costing® – Structure, Process and Cost Analysis – by System Plus Consulting

The Reverse Costing® report developed by System Plus Consulting provides full teardowns, including detailed photos, precise measurements, material analyses, manufacturing process flows, supply chain evaluations, manufacturing cost analyses and selling price estimations. The reports listed below are comparisons of several analyzed components from System Plus Consulting. More reports are however available, and over 60 reports will be released in 2019. The complete list is available at www.systemplus.fr.

Patent Reports – by KnowMade

More than describing the status of the IP situation, these analyses provide a missing link between patented technologies and market, technological and business trends. They offer an understanding of the competitive landscape and technology developments from a patent perspective. They include key insights into key IP players, key patents and future technology trends. For 2019 KnowMade will release over 15 reports.

The markets targeted are :

-  Mobile & Consumer
-  Automotive & Transportation
-  Medical
-  Industrial
-  Telecom & Infrastructure
-  Defense & Aerospace

Linked reports are dealing with the same topic to provide a more detailed analysis.

OUR 2019 REPORTS COLLECTION (1/5)

18 fields of excellence combined with six markets to provide a complete picture of your industry landscape

MEMS & SENSORS

○ MARKET AND TECHNOLOGY REPORT

- Status of the MEMS Industry 2019 - Update    
- Status of the Audio Industry 2019 - New 
- Uncooled Infrared Imagers and Detectors 2019 – Update  
- Consumer Biometrics: Technologies and Market Trends 2018 
- MEMS Pressure Sensor Market and Technologies 2018   
- Gas & Particle Sensors 2018   

○ STRUCTURE, PROCESS & COST REPORT

- MEMS & Sensors Comparison 2019   
- MEMS Pressure Sensor Comparison 2018   
- Particle Sensors Comparison 2019
- Miniaturized Gas Sensors Comparison 2018 

○ PATENT REPORT

- MEMS Foundry Business Portfolio 2019 - New 
- Miniaturized Gas Sensors 2019 - New 

PHOTONIC AND OPTOELECTRONICS

○ MARKET AND TECHNOLOGY REPORT













- Photonic Integrated Circuit 2019 - New    
- LiDARs for Automotive and Industrial Applications 2019 - Update  
- Silicon Photonics 2018    

○ PATENT REPORT

- Silicon Photonics for Data Centers: Optical Transceiver 2019 - New 
- LiDAR for Automotive 2018 

RF DEVICES AND TECHNOLOGIES

○ MARKET AND TECHNOLOGY REPORT

- RF GaN Market: Applications, Players, Technology, and Substrates 2019 - Update    
- 5G's Impact on RF Front-End Module and Connectivity for Cell Phones 2019 - Update 
- Radar and V2X Market & Technology for Automotive 2019 - Update 
- Advanced RF Antenna Market & Technology 2019 - New    
- RF Standards and Technologies for Connected Objects 2018   

○ STRUCTURE, PROCESS & COST REPORT

- RF Front-End Module Comparison 2019 - Update 
- Automotive Radar RF Chipset Comparison 2018 

○ PATENT REPORT

- Antenna for 5G Wireless Communications 2019 - New 
- RF Front End Modules for Cellphones 2018 
- RF Filter for 5G Wireless Communications: Materials and Technologies 2019   
- RF GaN : Materials, Devices and Modules 2018   

OUR 2019 REPORTS COLLECTION (2/5)

18 fields of excellence combined with six markets to provide a complete picture of your industry landscape

IMAGING

○ MARKET AND TECHNOLOGY REPORT

- Status of the CIS Industry 2019: Technology and Foundry Business - Update     
- Imaging for Automotive 2019 - Update 
- Neuromorphic Technologies for Sensing 2019 - Update  
- Status of the CCM and WLO Industry 2019 - Update 
- Machine Vision for Industry and Automation 2018 
- Sensors for Robotic Vehicles 2018 

○ STRUCTURE, PROCESS & COST REPORT

- Compact Camera Modules Comparison 2019 
- CMOS Image Sensors Comparison 2019 

○ PATENT REPORT

- Facial & Gesture Recognition Technologies in Mobile Devices 2019 - New 
- Apple iPhone X Proximity Sensor & Flood Illuminator 2018 

MEDICAL IMAGING AND BIOPHOTONICS

○ MARKET AND TECHNOLOGY REPORT

- X-Ray Flat Panel Detectors for Military, Industrial and Medical Applications 2019 - New   
- Microscopy Life Science Cameras: Market and Technology Analysis 2019 
- Ultrasound technologies for Medical, Industrial and Consumer Applications 2018   

○ PATENT REPORT

- Optical Coherence Tomography Medical Imaging 2018 

MICROFLUIDICS

○ MARKET AND TECHNOLOGY REPORT

- Status of the Microfluidics Industry 2019 - Update  
- Next Generation Sequencing & DNA Synthesis - Technology, Consumables Manufacturing and Market Trends 2019 - New 
- Organ-on-a-Chip Market & Technology Landscape 2019 - Update  
- Point-of-Need Testing Application of Microfluidic Technologies 2018  
- Liquid Biopsy: from Isolation to Downstream Applications 2018 
- Chinese Microfluidics Industry 2018 

○ PATENT REPORT

- Microfluidic Manufacturing Technologies 2019 – New 

INKJET AND ACCURATE DISPENSING

○ MARKET AND TECHNOLOGY REPORT

- Inkjet Printheads - Dispensing Technologies & Market Landscape 2019 - Update   
- Emerging Printing Technologies for Microsystem Manufacturing 2019 - New     
- Piezoelectric Materials from Bulk to Thin Film 2019 - New     
- Inkjet Functional and Additive Manufacturing for Electronics 2018  

○ STRUCTURE, PROCESS & COST REPORT

- Piezoelectric Materials from Bulk to Thin Film Comparison 2019   

OUR 2019 REPORTS COLLECTION (3/5)

18 fields of excellence combined with six markets to provide a complete picture of your industry landscape

BIOTECHNOLOGIES

○ MARKET AND TECHNOLOGY REPORT







- CRISPR-Cas9 Technology: From Lab to Industries 2018  

○ PATENT REPORT





- Personalized Medicine 2019 – New 

BIOMEMS & MEDICAL MICROSYSTEMS

○ MARKET AND TECHNOLOGY REPORT

- Medical Wearables: Market & Technology Analysis 2019 - New  
- Neurotechnologies and Brain Computer Interface 2018  
- BioMEMS & Non-Invasive Sensors: Microsystems for Life Sciences & Healthcare 2018  

○ PATENT REPORT

- 3D Cell Printing 2019 - New 
- Circulating Tumor Cells Isolation 2019 - New 
- Nanopore Sequencing 2019 - New  









SOFTWARE AND COMPUTING

○ MARKET AND TECHNOLOGY REPORT

- Hardware and Software for Artificial Intelligence (AI) in Automotive Applications 2019 - New 
- Hardware and Software for Artificial Intelligence (AI) in Consumer Applications 2019 - Update 
- From Image Processing to Deep Learning 2019 - Update    
- xPU (Processing Units) for Cryptocurrency, Blockchain, HPC and Gaming 2019 – New  

MEMORY

○ MARKET AND TECHNOLOGY REPORT

- Status of the Memory Business 2019 - New    
- MRAM Technology and Business 2019 - New    
- Emerging Non Volatile Memory 2018

○ STRUCTURE, PROCESS & COST REPORT

- Memory Comparison 2019 

○ PATENT REPORT

- Magnetoresistive Random-Access Memory (MRAM) 2019 - New    
- 3D Non-Volatile Memory 2018    

ADVANCED PACKAGING

○ MARKET AND TECHNOLOGY REPORT

- Fan Out Packaging Technologies and Market Trends 2019 - Update    
- 3D TSV Integration and Monolithic Business Update 2019 - Update    
- Advanced RF SiP for Cellphones 2019 - Update  
- Status of Advanced Packaging 2019 - Update    
- Status of Advanced Substrates 2019 - Update    
- Panel Level Packaging Trends 2019 - Update    
- RF System-in-Package & Materials for 5G 2019 - New  
- System in Package (SiP) Technology and Market Trends 2019 - New    
- Trends in Automotive Packaging 2018 
- Thin-Film Integrated Passive Devices 2018    

○ STRUCTURE, PROCESS & COST REPORT

- Advanced RF SiP for Cellphones Comparison 2019 

OUR 2019 REPORTS COLLECTION (4/5)

18 fields of excellence combined with six markets to provide a complete picture of your industry landscape

SEMICONDUCTOR MANUFACTURING

○ MARKET AND TECHNOLOGY REPORT

- Nano Imprint Lithography 2019 - New     
- Equipment and Materials for Fan Out Packaging 2019 - Update     
- Equipment for More than Moore: Thin Film Deposition & Etching 2019 - New     
- Wafer Starts for More Than Moore Applications 2018     
- Polymeric Materials at Wafer-Level for Advanced Packaging 2018     
- Bonding and Lithography Equipment Market for More than Moore Devices 2018     

○ STRUCTURE, PROCESS & COST REPORT

- Wafer Bonding Comparison 2018  

○ PATENT REPORT

- Hybrid Bonding for 3D Stack 2019 – New     

SOLID STATE LIGHTING

○ MARKET AND TECHNOLOGY REPORT

- Status of the Solid State Light Source Industry 2019 - New     
- Edge Emitting Lasers (EELS) 2019 - New     
- Light Shaping Technologies 2019 - New     
- Automotive Advanced Front Lighting Systems 2019 - New 
- VCSELs - Technology, Industry and Market Trends 2019 - Update     
- IR LEDs and Laser Diodes – Technology, Applications, and Industry Trends 2018 
- Automotive Lighting 2018: Technology, Industry and Market Trends 
- UV LEDs - Technology, Manufacturing and Application Trends 2018 
- LiFi: Technology, Industry and Market Trends 2018 

○ STRUCTURE, PROCESS & COST REPORT



















- VCSEL Comparison 2019 

○ PATENT REPORT

- VCSELs 2018  

DISPLAY

○ MARKET AND TECHNOLOGY REPORT

- Next Generation 3D Display 2019 - New     
- Next Generation Human Machine Interaction (HMI) in Displays 2019 - New 
- Micro-and Mini-LED Displays 2019 - Update     
- QD and Wide Color gamut (WCG) Display Technologies 2019 - Update     
- Displays & Optical Vision Systems for VR, AR & MR 2018  

○ PATENT REPORT

- MicroLED Displays : Intellectual Property Landscape 2018 

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POWER ELECTRONICS





○ MARKET AND TECHNOLOGY REPORT

- Power SiC: Materials, Devices and Applications 2019 - Update    
- Power Electronics for EV/HEV and e-mobility: Market, Innovations and Trends 2019 - Update 
- Status of the Power Electronics Industry 2019 - Update    
- Discrete Power Packaging : Material Market and Technology Trends 2019 - New    
- Status of the Power ICs Industry 2019 - Update    
- Status of the Passive Components for the Power Electronics Industry 2019 - Update    
- Status of the Inverter Industry 2019 - Update    
- Status of the Power Module Packaging Industry 2019 - Update 
- Wireless Charging Market Expectations and Technology Trends 2018    

○ STRUCTURE, PROCESS & COST REPORT




- Automotive Power Module Packaging Comparison 2018 
- GaN-on-Silicon Transistor Comparison 2019  
- SiC Transistor Comparison 2019 

○ PATENT REPORT

- Power SiC : Materials, Devices and Modules 2019 - New  
- Power GaN : Materials, Devices and Modules 2019 – Update  

BATTERY & ENERGY MANAGEMENT

○ MARKET AND TECHNOLOGY REPORT

- Status of the Rechargeable Li-ion Battery Industry 2019 - New    
- Li-ion Battery Packs for Automotive and Stationary Storage Applications 2019 - Update  

○ PATENT REPORT

- Battery Energy Density Increase: Materials and Emerging Technologies 2019 - New  
- Solid-State Batteries 2019 - New    
- Status of the Battery Patents 2018    

COMPOUND SEMI.

○ MARKET AND TECHNOLOGY REPORT

- Emerging Compound Semiconductor Market & Technology Trends 2019 - New    
- Status of the Compound Semiconductor Industry 2019 - New    
- InP Materials, Devices and Applications 2019 - New    
- GaAs Wafer and Epiwafer Market: RF, Photonics, LED and PV Applications 2018    

○ PATENT REPORT

- GaN-on-Silicon Substrate: Materials, Devices and Applications 2019 - Update    

OUR 2019 MONITORS COLLECTION (1/2)

Get the most updated overview of your market to monitor your strategy

Yole Développement, System Plus Consulting and KnowMade, all part of the Yole Group of Companies, are launching a collection of 10 monitors in 2019. The monitors aim to provide updated market, technology and patent data as well dedicated quarterly analyses of the evolution in your industry over the previous 12 months. Furthermore, you can benefit from direct access to the analyst for an on-demand Q&A and discussion session regarding trend analyses, forecasts and breaking news.

Topics covered will be compact camera modules (CCMs), advanced packaging, compound semiconductors, microfluidics, batteries, RF and memory.

MARKET MONITOR by Yole Développement

A FULL PACKAGE:

The monitors will provide the evolution of the market in units, wafer area and revenues. They will also offer insights into what is driving the business and a close look at what is happening will also be covered in it.

The following deliverables will be included in the monitors:

- An Excel database with all historical and forecast data
 - A PDF slide deck with graphs and comments/analyses covering the expected evolutions
- **ADVANCED PACKAGING – NEW**
This monitor will provide the evolution of the advanced packaging platforms. It will cover Fan-Out Wafer Level Packaging (WLP), Fan-Out Panel Level Packaging (PLP), Wafer-Level Chip Scale Packaging (WLCSP), Flip Chip packaging platforms, and 2.5D and 3D Through Silicon Via (TSV) integration. *Frequency: Quarterly, starting from Q3 2019*

REVERSE TECHNOLOGY MONITOR by System Plus Consulting

- **SMARTPHONES – NEW**
To stay updated on the latest components, packaging and silicon chip choices of the smartphone makers, System Plus Consulting has created its first Smartphone Reverse Technology monitor. This year, get access to the packaging and silicon content database of at least 20 different flagship smartphones – more than five per quarter. Starting at the beginning of 2019, the monitor will include an Excel database report for each phone and a quarterly comparison.

- **COMPOUND SEMI. – NEW**

This monitor will describe how the compound semiconductor industry is evolving. It will offer a close look at GaAs, InP, SiC, GaN and other compounds of interest providing wafer volumes, revenues, application breakdowns and momentum. *Frequency: Quarterly, starting from Q3 2019*

- **CAMERA MODULE – NEW**

This monitor will provide the evolution of the imaging industry, with a close look at image sensor, camera module, lens and VCM. Volumes, revenues and momentum of companies like Sony, Samsung, Omnivision and OnSemi will thus be analysed. *Frequency: Quarterly, starting from Q3 2019*

- **MEMORY – UPDATE**

For the memory industry you can have access to a quarterly monitor, as well as an additional service, a monthly pricing. Both services can be bought separately:

- DRAM Service: Including a quarterly monitor and monthly pricing.
- NAND Service: Including a quarterly monitor and monthly pricing.



Get the most updated overview of your market to monitor your strategy

PATENT MONITOR by KnowMade

A FULL PACKAGE:

Starting at the beginning of the year, the KnowMade monitors include the following deliverables:

- An Excel file including the monthly IP database of:
 - New patent applications
 - Newly granted patents
 - Expired or abandoned patents
 - Transfer of IP rights through re-assignment and licensing
 - Patent litigation and opposition
- Quarterly report including a PDF slide deck with the key facts & figures of the quarter: IP trends over the three last months, with a close look to key IP players and key patented technologies.
- **GaN for Power & RF Electronics**
Wafers and epiwafers, GaN-on-SiC, silicon, sapphire or diamond, semiconductor devices such as transistors, and diodes, devices and applications including converters, rectifiers, switches, amplifiers, filters, and Monolithic Microwave Integrated Circuits (MMICs), packaging, modules and systems.
- **GaN for Optoelectronics & Photonics**
Wafers and epiwafers, GaN-on-sapphire, SiC or silicon; semiconductor devices such as LEDs and lasers; and applications including lighting, display, visible communication, photonics, packaging, modules and systems.
- **Li-ion Batteries**
Anodes made of lithium metal, silicon, and lithium titanate (LTO); cathodes made of Lithium Iron Phosphate (LFP), Nickel-Manganese-Cobalt (NMC), Lithium Nickel Cobalt Aluminium Oxide (NCA), Lithium Nickel Metal Dioxide (LiNiMO₂), Lithium Metal Phosphate (LiMPO₄), and Lithium Metal Tetroxide (LiMO₄); electrolytes including liquid, polymer/gel, and solid inorganics; ceramic and other separators; battery cells including thin film/microbattery, flexible, cylindrical and prismatic; and battery packs and systems.
- **Post Li-ion Batteries**
Battery technologies including redox-flow batteries, sodium-ion, lithiumsulfur, lithium-air, and magnesium-ion, and their supply chains, including electrodes, electrolytes, battery cells and battery packs/systems.
- **Solid-State Batteries**
Supply chain including electrodes, battery cells, battery packs/systems and electrolytes, including polymer, inorganic and inorganic/polymer, inorganic materials, including argyrodites, Lithium Super Ionic CONductor, (LISICONs), Thio-LISICONs, sulfide glasses, oxide glasses, perovskites, anti-perovskites and garnets.
- **RF Acoustic Wave Filters**
Including Surface Acoustic Wave (SAW), Temperature Compensated (TC)- SAW, Bulk Acoustic Wave- Free-standing Bulk Acoustic Resonator (BAWFBAR), BAW-Solidly-Mounted Resonator (BAW-SMR), and Packaging.
- **RF Power Amplifiers**
Including Low Noise Amplifiers, Doherty Amplifiers, Packaging, and Millimeter-Wave technology.
- **RF Front-End Modules**
- **Microfluidics**
From components to chips and systems, including all applications.

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